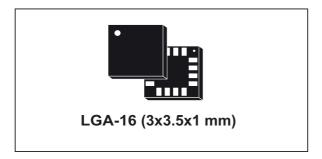


MEMS motion sensor:

three-axis digital output gyroscope for optical image stabilization

Datasheet - production data



Features

- ±65 dps / ±130 dps full-scale range
- SPI digital interface
- Embedded temperature sensor
- Integrated low- and high-pass filters with userselectable bandwidth
- Wide supply voltage range: 2.4 V to 3.6 V
- Low-voltage compatible IOs (1.8 V)
- Power-down and sleep modes for smart power saving
- ECOPACK[®], RoHS and "Green" compliant

Applications

· Optical image stabilization

Description

The L3G3IS is a three-axis MEMS gyroscope for optical image stabilization applications.

It includes a sensing element and an IC interface capable of providing the measured angular rate to the external world through an SPI digital interface.

The unique sensing element is manufactured using a dedicated micromachining process developed by STMicroelectronics to produce inertial sensors and actuators on silicon wafers.

The IC interface is manufactured using a CMOS process that allows a high level of integration to design a dedicated circuit which is trimmed to better match the sensing element characteristics.

The L3G3IS is available in a plastic land grid array (LGA) package and can operate over a temperature range of -40 °C to +85 °C.

Table 1. Device summary

Order code	Temperature range (°C)	Package	Packing
L3G3IS	-40 to +85	LGA-16 (3x3.5x1)	Tray
L3G3ISTR	-40 to +85	LGA-16 (3x3.5x1)	Tape and reel

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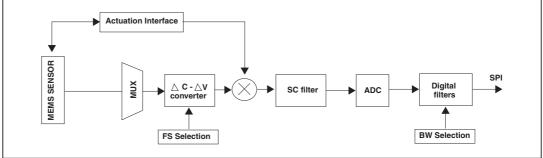
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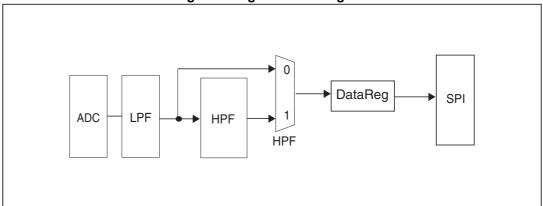
1 Block diagrams and pin description

Figure 1. Block diagram



1.1 Digital block diagram

Figure 2. Digital block diagram



1.2 Pin description

Figure 3. Pin connections

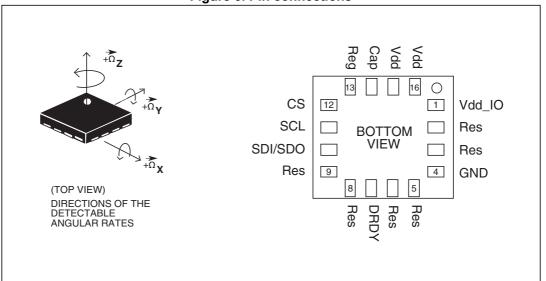


Table 2. Pin description

Pin#	Name	Function
1	Vdd_IO	Power supply for I/O pins
2	Res	Connect to GND
3	Res	Connect to GND
4	GND	0 V power supply
5	Res	Leave unconnected
6	Res	Connect to GND
7	DRDY	Data ready signal (open-drain pad)
8	Res	Leave unconnected
9	Res	Leave unconnected
10	SDI/SDO	Data-in, data-out line
11	SCL	Clock line for SPI interface
12	CS	SPI chip-select line
13	Reg	Capacitance connection pin for internal regulator
14	Сар	Capacitance connection pin for internal charge pump
15	Vdd	Power supply
16	Vdd	Power supply

2 Terminology & functionality

2.1 Sensitivity

An angular rate gyroscope is a device that produces a positive-going digital output for counterclockwise rotation around the sensitive axis considered. Sensitivity describes the gain of the sensor and can be determined by applying a defined angular velocity to it. This value changes very little over temperature and time.

2.2 Zero-rate level

The zero-rate level describes the actual output signal if there is no angular rate present. The zero-rate level of highly accurate MEMS sensors is, to some extent, a result of stress to the sensor and therefore the zero-rate level can slightly change after mounting the sensor on a printed circuit board or after exposing it to extensive mechanical stress. This value changes very little over temperature and time.

2.3 Synchronous reading

On the L3G3IS the angular rate data can be retrieved using a synchronous read. This functionality is recommended to improve the sensor performance.

To perform a synchronous read when using the SPI interface, the REG_EN bit in *CTRL_REG1* (0Bh) has to be set to '1'. Then the DRDY_EN bit in *CTRL_REG4* (15h) has to be set to '1' in order to enable the data ready interrupt on the DRDY pin (refer to *Figure 5*).

To properly perform a synchronous read, the angular rate data have to be read every time the DRDY pin goes low.

2.4 Temperature sensor

To retrieve the temperature data, the gyroscope has to be in sleep mode (PW<1:0> bit in CTRL_REG1 (0Bh) set to '10'), the REG_EN bit in CTRL_REG1 (0Bh) has to be set to '1' and the temperature sensor can be enabled by setting the TEMP_EN bit to '1' in CTRL_TEMP (20h).

The temperature data can be retrieved from the *OUT_TEMP (26h)* register, as two's complement data in 8-bit format left-justified. The output of the temperature sensor is 0 at 25 °C.

Once the temperature data have been acquired, the temperature sensor has to be turned off to restart the acquisition of the angular rate data. The TEMP_EN bit in *CTRL_TEMP* (20h) has to be set to '0' and the gyroscope operative mode has to be changed to normal mode (PW<1:0> bit in *CTRL_REG1* (0Bh) set to '11').



3 Mechanical and electrical characteristics

3.1 Mechanical characteristics

Vdd = 3.3 V and T = 25 °C unless otherwise noted^(a).

Table 3. Mechanical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
FS	Magaurament range		±65			dno
F3	Measurement range		±130			dps
So	Conditivity	FS = ±65 dps		225		I Sh/dns
30	Sensitivity	FS = ±130 dps		112.5		LSb/dps
SoDr	Sensitivity change vs. temperature	From -40 °C to +85 °C		±3		%
DVoff	Digital zero-rate level			±5		dps
OffDr	Zero-rate level change vs. temperature	From -40 °C to +85 °C		±9		dps
NL	Non-linearity ⁽²⁾	Best-fit straight line		±0.1		% FS
Rn	Rate noise density ⁽²⁾	0 - 20 Hz bandwidth		0.006		dps/(√Hz)
BW	Internal bandwidth	LPF set to '1'		370		Hz
PhDI	Phase delay	At 20 Hz (370 Hz BW selected)		4.5		deg
ODR	Digital output data rate			9.5		kHz
Тор	Operating temperature range		-40		+85	°C

^{1.} Typical specifications are not guaranteed.

a. The product is factory calibrated at 3.3 V. The operational power supply range is specified in *Table 4*.



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^{2.} Guaranteed by design.

3.2 Electrical characteristics

0 Vdd = 3.3 V, T = 25 °C unless otherwise noted^(b).

Table 4. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		2.42	3.3	3.6	V
Vdd_IO	I/O pins supply voltage ⁽²⁾		1.71		Vdd+0.1	V
ldd	Supply current in normal mode			6.4		mA
IddSL	Supply current in sleep mode ⁽³⁾			2.5		mA
IddPdn	Supply current in power-down mode			20		μА
VIH	Digital high-level input voltage		0.8*Vdd_IO			V
VIL	Digital low-level input voltage				0.2*Vdd_IO	V
Тор	Operating temperature range		-40		+85	°C

^{1.} Typical specifications are not guaranteed.

57

^{2.} It is possible to remove Vdd maintaining Vdd_IO without blocking the communication busses, in this condition the measurement chain is powered off.

^{3.} Sleep mode introduces a faster turn-on time relative to power-down mode.

b. The product is factory calibrated at 3.3 V.

3.3 Temperature sensor characteristics

@ AVdd = 3.3 V, T = 25 °C unless otherwise noted^(C).

Table 5. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Typ. ⁽¹⁾	Max.	Unit
TSDr	Temperature sensor output change vs. temperature			1		°C/digit
TODR	Temperature refresh rate			1		Hz
TACC	Temperature absolute accuracy ⁽²⁾			±4		°C
Тор	Operating temperature range		-40		+85	°C

^{1.} Typical specifications are not guaranteed.

c. The product is factory calibrated at 3.3 V.



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^{2.} The output of the temperature sensor is 0 at 25 °C. Refer to Section 2.4: Temperature sensor on how to enable and read the temperature sensor output data.

SPI - serial peripheral interface 3.4

Subject to general operating conditions for Vdd and Top.

Table 6. SPI slave timing values

O	Paramatan.	Val	Value ⁽¹⁾		
Symbol	Parameter	Min	Max	- Unit	
t _{c(SPC)}	SPI clock cycle	100		ns	
f _{c(SPC)}	SPI clock frequency		10	MHz	
t _{su(CS)}	CS setup time	5			
t _{h(CS)}	CS hold time	8			
t _{su(SI)}	SDI input setup time	5		1	
t _{h(SI)}	SDI input hold time	15		ns	
t _{v(SO)}	SDO valid output time		50		
t _{h(SO)}	SDO output hold time	6			
t _{dis(SO)}	SDO output disable time		50		

^{1.} Values are guaranteed at 10 MHz clock frequency for SPI, based on characterization results, not tested in production.

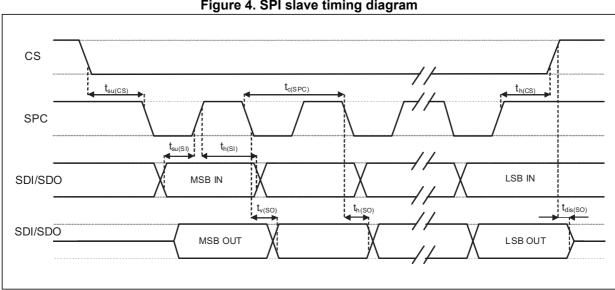


Figure 4. SPI slave timing diagram

Note: Measurement points are done at 0.2·Vdd_IO and 0.8·Vdd_IO, for both input and output ports.

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Absolute maximum ratings 3.5

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Table 7. Absolute maximum ratings

Symbol	Ratings	Maximum value	Unit
AVdd	Supply voltage	-0.3 to 4.8	V
HAVdd	Supply voltage	-0.3 to 4.8	V
Vdd_IO	Vdd IO	-0.3 to Vdd	V
Vin	Input voltage on: (CS, SDI/SDO, SCL)	-0.3 to Vdd_IO +0.1	V
T _{STG}	Storage temperature range	-40 to +125	°C
Sg	Acceleration g for 0.1 ms	10,000	g
ESD	Electrostatic discharge protection	2 (HBM)	kV

Note: Supply voltage on any pin should never exceed 4.8 V.



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.



This device is sensitive to electrostatic discharge (ESD), improper handling can cause permanent damage to the part.



Application hints L3G3IS

4 Application hints

GND C1 C4 Vdd ρpΛ GND O 16 CS Vdd_IO 1 12 TOP SCL Res **VIEW** SDI/SDO Res (TOP VIEW) GND 4 9 Res¹ **DIRECTIONS OF THE** DETECTABLE ANGULAR RATES Res¹ Res ≿ Res¹ In case of synchronous reading: Vdd_IO DRDY 1. This pin must be left unconnected

Figure 5. L3G3IS electrical connections and external component values

Table 8. External components

Type description	Value	Purpose
C1	1 μF	Decoupling
C2	100 pF	Decoupling
C3 ⁽¹⁾	10 nF (16 V class)	Charge pump
C4	220 nF (5 V class)	Internal regulator

^{1.} This value must guarantee a minimum of 1 nF value under 12 V bias condition.

Power supply decoupling capacitors (100 pF + 1 μ F) should be placed as near as possible to the device (common design practice). A pull-up resistor must be added to the DRDY line (open-drain pad).

L3G3IS Digital interfaces

5 Digital interfaces

The registers embedded inside the L3G3IS may be accessed through the SPI serial interfaces.

Pin name
Pin description

CS
Chip-select line
SCL
SPI serial port clock
SDI/SDO
SPI serial data input/output

Table 9. Serial interface pin description

5.1 SPI bus interface

The SPI is a bus slave. The SPI allows to write and read the registers of the device.

The serial interface interacts with the outside world with 3 wires: CS, SCL, SDI/SDO.

CS is the serial port enable and it is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. **SCL** is the serial port clock and it is controlled by the SPI master. It is stopped high when **CS** is high (no transmission). **SDI/SDO** is the serial port data input and output. This line is driven at the falling edge of **SCL** and should be captured at the rising edge of **SCL**.

Both the read register and write register commands are completed in 16 clock pulses or in multiples of 8 in case of multiple read/write bytes. Bit duration is the time between two falling edges of **SCL**. The first bit (bit 0) starts at the first falling edge of **SCL** after the falling edge of **CS** while the last bit (bit 15, bit 23, ...) starts at the last falling edge of **SCL** just before the rising edge of **CS**.

5.1.1 SPI write

Figure 6. SPI write protocol

The SPI write command is performed with 16 clock pulses. A multiple byte write command is performed by adding blocks of 8 clock pulses to the previous one.

bit 0: WRITE bit. The value is 0.

bit 1: \overline{MS} bit. When 0, does not increment the address; when 1, increments the address in multiple writes.

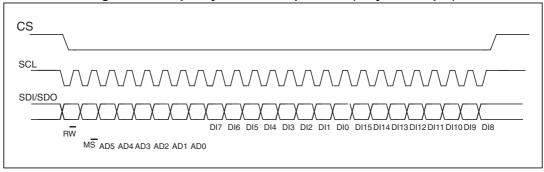
bit 2 -7: address AD(5:0). This is the address field of the indexed register.

Digital interfaces L3G3IS

bit 8-15: data DI(7:0) (write mode). This is the data that will be written inside the device (MSb first).

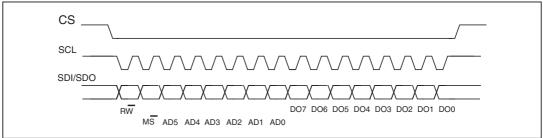
bit 16-...: data DI(...-8). Further data in multiple byte writes.

Figure 7. Multiple byte SPI write protocol (2-byte example)



5.1.2 SPI read

Figure 8. SPI read protocol



The SPI Read command is performed with 16 clock pulses:

bit 0: READ bit. The value is 1.

bit 1: \overline{MS} bit. When 0, does not increment the address; when 1, increments the address in multiple reads.

bit 2-7: address AD(5:0). This is the address field of the indexed register.

bit 8-15: data DO(7:0) (read mode). This is the data that will be read from the device (MSb first).

A multiple read command is also available.

6 Output register mapping

The table given below provides a listing of the 8-bit registers embedded in the device and the related addresses.

Table 10. Register address map

Type	Register address [Hex]	Default [Hex]	Comment
	00-02		Reserved
r	03	output	
r	04	output	
r	05	output	
r	06	output	
r	07	output	
r	08	output	
r	09	output	
	0A		Reserved
rw	0B	01	
rw	0C	00	
rw	0D	00	
rw	10	00	
	11-14		Reserved
rw	15	00	
	16-1E		Reserved
rw	1F	00	
rw	20	04	
	21-25		Reserved
r	26	output	
	r r r r r r r r r r r r r r r r r r	Type address [Hex] 00-02 r 03 r 04 r 05 r 06 r 07 r 08 r 09 0A rw 0B rw 0C rw 0D rw 10 11-14 rw 15 16-1E rw 1F rw 20 21-25	Type address [Hex] Default [Hex] 00-02 r 03 output r 04 output r 05 output r 06 output r 07 output r 08 output r 09 output 0A rw 0B 01 rw 0C 00 rw 0D 00 rw 10 00 11-14 rw 15 00 16-1E rw 1F 00 rw 20 04 21-25

Registers marked as Reserved must not be changed. Writing to those registers may cause permanent damage to the device.

To guarantee proper behavior of the device, all register addresses not listed in the above table must not be accessed and the content stored in those registers must not be changed.

The content of the registers that are loaded at boot should not be changed. They contain the factory calibration values. Their content is automatically restored when the device is powered up.



Register description L3G3IS

7 Register description

The device contains a set of registers which are used to control its behavior and to retrieve angular rate data. The register address, consisting of 7 bits, is used to identify them and to write the data through the serial interface.

7.1 OUT_X_L (03h), OUT_X_H (04h)

X-axis angular rate data. The value is expressed as two's complement.

7.2 OUT_Y_L (05h), OUT_Y_H (06h)

Y-axis angular rate data. The value is expressed as two's complement.

7.3 OUT_Z_L (07h), OUT_Z_H (08h)

Z-axis angular rate data. The value is expressed as two's complement.

7.4 **STATUS_REG** (09h)

Table 11. STATUS_REG register

ZYXOR XOR YOR	ZOR	ZYXDA	XDA	YDA	ZDA
---------------	-----	-------	-----	-----	-----

Table 12. STATUS_REG description

ZYXOR	X, Y, Z -axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data has overwritten the previous data)
XOR	X-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the X-axis has overwritten the previous data)
YOR	Y-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Y-axis has overwritten the previous data)
ZOR	Z-axis data overrun. Default value: 0 (0: no overrun has occurred; 1: new data for the Z-axis has overwritten the previous data)
ZYXDA	X, Y, Z -axis new data available. Default value: 0 (0: a new set of data is not yet available; 1: a new set of data is available)
XDA	X-axis new data available. Default value: 0 (0: new data for the X-axis is not yet available; 1: new data for the X-axis is available)
YDA	Y-axis new data available. Default value: 0 (0: new data for the Y-axis is not yet available;1: new data for the Y-axis is available)
ZDA	Z-axis new data available. Default value: 0 (0: new data for the Z-axis is not yet available; 1: new data for the Z-axis is available)

7.5 CTRL_REG1 (0Bh)

Table 13. CTRL_REG1 register

0 ⁽¹⁾	0 ⁽¹⁾	0 ⁽¹⁾	0 ⁽¹⁾	BDU	REG_EN	PW1	PW0

^{1.} These bits must be set to '0' for proper operation of the device.

Table 14. CTRL_REG1 description

BDU	Block data update. Default value: 0. (0: output registers not updated until MSB and LSB have been read; 1: output registers updated continuously)
REG_EN	Enables writing to CTRL_REG4 (15h), CTRL_REG5 (1Fh) and CTRL_TEMP (20h). Default value: 0. (1: enable write values in CTRL_REG4 (15h), CTRL_REG5 (1Fh)) and CTRL_TEMP (20h))
PW[1:0]	Operating mode selection. Default: 01. Refer to Table 15: Operating mode selection.

Table 15. Operating mode selection

PW1	PW0	Operating mode selection
0	0	Power-down
0	1	Power-down
1	0	Sleep mode
1	1	Normal mode

7.6 CTRL_REG2 (0Ch)

Table 16. CTRL_REG2 register

	0 ⁽¹⁾	0 ⁽¹⁾	0 ⁽¹⁾	HPFreset0	HPFreset1	HPFreset2	SWreset	HPF
- 1	•	· ·	_				011.0001	

^{1.} These bits must be set to '0' for proper operation of the device.

Table 17. CTRL_REG2 description

HPFreset0	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
HPFreset1	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
HPFreset2	High-pass filter reset. Default: 0. To reset the HPF, HPFreset2 or HPFreset1 or HPFreset0 has to be set to 1. (1: HPF reset on X-axis, Y-axis and Z-axis)
SWreset	Software reset. Default: 0. (1: all control and output register values are restored to default values).
HPF	High-pass filter enable. Default: 0. (0: high-pass filter is disabled; 1: high-pass filter is enabled)



Register description L3G3IS

7.7 CTRL_REG3 (0Dh)

Table 18. CTRL_REG3 register

-								
	0 ⁽¹⁾	LPF						

^{1.} These bits must be set to '0' for proper operation of the device

Table 19. CTRL_REG3 description

	Low-pass filter cutoff frequency selection. Default value 0.
I PF	(0: 120Hz; 1: 370Hz).
LFF	If LPF2 in CTRL_REG5 (1Fh) is set to '1', the cutoff frequency is set to 240 Hz, independently of the value of LPF.

Table 20. Low-pass filter cutoff frequency

LPF	LPF2 (CTRL_REG5 (1Fh))	Low-pass filter cutoff frequency selection
0	0	120 Hz
1	0	370 Hz
0	1	240 Hz
1	1	240 Hz

7.8 ORIENT_CONFIG (10h)

Table 21. ORIENT_CONFIG register

	ſ	0 ⁽¹⁾	0 ⁽¹⁾	Sign_x	Sign_y	Sign_z	Orient_2	Orient_1	Orient_0
--	---	------------------	------------------	--------	--------	--------	----------	----------	----------

^{1.} These bits must be set to '0' for proper operation of the device

Table 22. ORIENT_CONFIG description

Sign_x	X-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)
Sign_y Y-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)	
Sign_Z	Z-axis angular rate sign. Default 0. (0: sign unvaried; 1: sign inverted)
Orient[2:0]	Directional orientation selection. Default 000. Refer to Table 23: Directional orientation selection

	145.5 20. 5.1001.0.14. 0.101.14.10.1. 00.1001.0.1						
Orient_2 Orient_1 Orient_0 Directional orientation selection							
0	0	0	x-axis - y-axis - z-axis				
0 0 1		1	x-axis - z-axis - y-axis				
0	1	0	y-axis - x-axis - z-axis				
0	1	1	z-axis - x-axis - y-axis				
1	0	0	y-axis - z-axis - x-axis				
1	0	1	z-axis - y-axis - x-axis				

Table 23. Directional orientation selection

7.9 CTRL_REG4 (15h)

To enable writing to the *CTRL_REG4* (15h) register, the REG_EN bit in *CTRL_REG1* (0Bh) has to be set to '1'.

Table 24. CTRL_REG4 register

0 ⁽¹⁾	DRDY_EN						
------------------	------------------	------------------	------------------	------------------	------------------	------------------	---------

^{1.} These bits must be set to '0' for proper operation of the devic.e

Table 25. CTRL_REG4 description

DRDY_EN	Data ready enable on DRDY pin. Default 0.
	(1: DRDY on pin). Refer to Section 2.3: Synchronous reading.

7.10 CTRL_REG5 (1Fh)

To enable writing to the *CTRL_REG5* (1Fh) register, the REG_EN bit in *CTRL_REG1* (0Bh) has to be set to '1'.

Table 26. CTRL_REG5 register

		_	•		
	 	 FS	LPF2	HPF_BW1	HPF_BW0

Table 27. CTRL_REG5 description

FS	Full-scale selection. Default value: 0 (0: ±65 dps; 1: ±130 dps)
LPF2	Enable low-pass filter 240 Hz. Default 0. If LPF2 is enabled, the cutoff frequency is set to 240 Hz, independently of the value of the LPF bit in CTRL_REG3 (0Dh). Refer to Table 20: Low-pass filter cutoff frequency.
HPF_BW[1:0]	Digital high-pass filter cutoff frequency selection. Default value 00. Refer to Table 28: High-pass filter cutoff frequency selection



Register description L3G3IS

Table 28. High-p	ass filter cutoff	frequenc	v selection

HPF_BW1	HPF_BW0	HP cutoff frequency selection		
0	0	0.02 Hz		
0	1	0.08 Hz		
1	0	4.85 Hz		
1	1	39.6 Hz		

7.11 CTRL_TEMP (20h)

To enable writing to the CTRL_TEMP (20h) register, the REG_EN bit in CTRL_REG1 (0Bh) has to be set to '1'.

Table 29. CTRL_TEMP register

				_ ~	,		
0 ⁽¹⁾	0 ⁽¹⁾	0 ⁽¹⁾	0 ⁽¹⁾	TEMP_EN	1 ⁽²⁾	0 ⁽¹⁾	0 ⁽¹⁾

- 1. These bits must be set to '0' for proper operation of the device.
- 2. This bit must be left at '1' for proper operation of the device.

Table 30. CTRL_TEMP description

TEMP_EN	Temperature sensor enable. Default 0
	(0: temperature sensor is disabled; 1: temperature sensor is enabled).
	Refer to: Section 2.4: Temperature sensor on how to enable and read the
	temperature sensor output data.

7.12 OUT_TEMP (26h)

Table 31. OUT_TEMP register

	Temp7	Temp6	Temp5	Temp4	Temp3	Temp2	Temp1	Temp0
- 1								

Table 32. OUT_TEMP description

Temp7-Temp0	Temperature data. The value is expressed as two's complement left-justified. The output of the temperature sensor is 0 at 25 °C.	
	Refer to: Section 2.4: Temperature sensor on how to enable and read the temperature sensor output data.	

8 Soldering information

The LGA package is compliant with the ECOPACK $^{\circledR}$, RoHS and "Green" standard. It is qualified for soldering heat resistance according to JEDEC J-STD-020.

Leave "Pin 1 Indicator" unconnected during soldering.

Land pattern and soldering recommendations are available at www.st.com/mems.



Package information L3G3IS

9 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Dimensions (mm) Min. Тур. Max. A1 1 A2 0.785 А3 0.200 D1 2.850 3.000 3.150 E1 3.500 L 1.750 Ν 0.500 М 0.100 0.160 0.040 M1 0.290 0.350 0.410 Р 1.200 T1 0.290 0.350 0.410 T2 0.190 0.250 0.310 d 0.150 k 0.050 Pin 1 Indicator Κ С Pin 1 Indicator Κ D D $|\Phi|$ Κ E \Box Ε В TOP VIEW BOTTOM VIEW seating plane 8409170_A

Figure 9. LGA-16: mechanical data and package dimensions

L3G3IS Revision history

10 Revision history

Table 33. Document revision history

Date	Revision	Changes
16-Jul-2013	1	Initial release
28-Aug-2013	2	Updated Figure 3: Pin connections and Figure 5: L3G3IS electrical connections and external component values Moved Figure 2: Digital block diagram
05-Dec-2013	3	Document status promoted from preliminary data to production data; updated Table 16: CTRL_REG2 register and Table 17: CTRL_REG2 description

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